



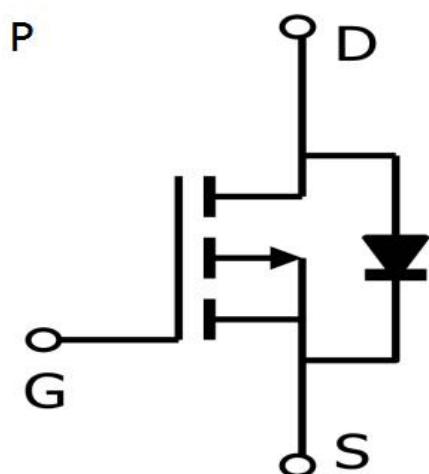
SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

SOT-23-3L Plastic-Encapsulate MOSFETS**MK2323A****P-Channel 20-V(D-S) MOSFET**

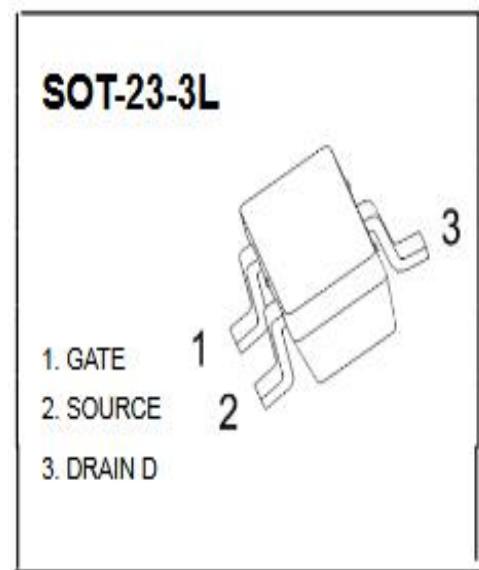
V(BR)DSS	RDS(on)MAX	ID
-20 V	30mΩ @ -4.5V	-6 A
	35mΩ @ -2.5V	

FEATURE

- TrenchFET Power MOSFET
- Fast switching speed
- High performance trench technology
- Low RDS(on) provides higher efficiency and extends battery life

MARKING**Equivalent Circuit****APPLICATION**

- ※ Load Switch for Portable Devices
- ※ DC/DC Converter

**Maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _D S	-20	V
Gate-Source Voltage	V _G S	±8	
Continuous Drain Current	I _D	-6	A
Pulsed Diode Current	I _{DM}	-18	
Power Dissipation	P _D	1.25	W
Thermal Resistance from Junction to Ambient (t≤5s)	R _{θJA}	100	°C/W
Operating Junction	T _J	150	°C
Storage Temperature	T _{STG}	-55~+150	



MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics (Ta = 25 °C Unless Otherwise Noted)

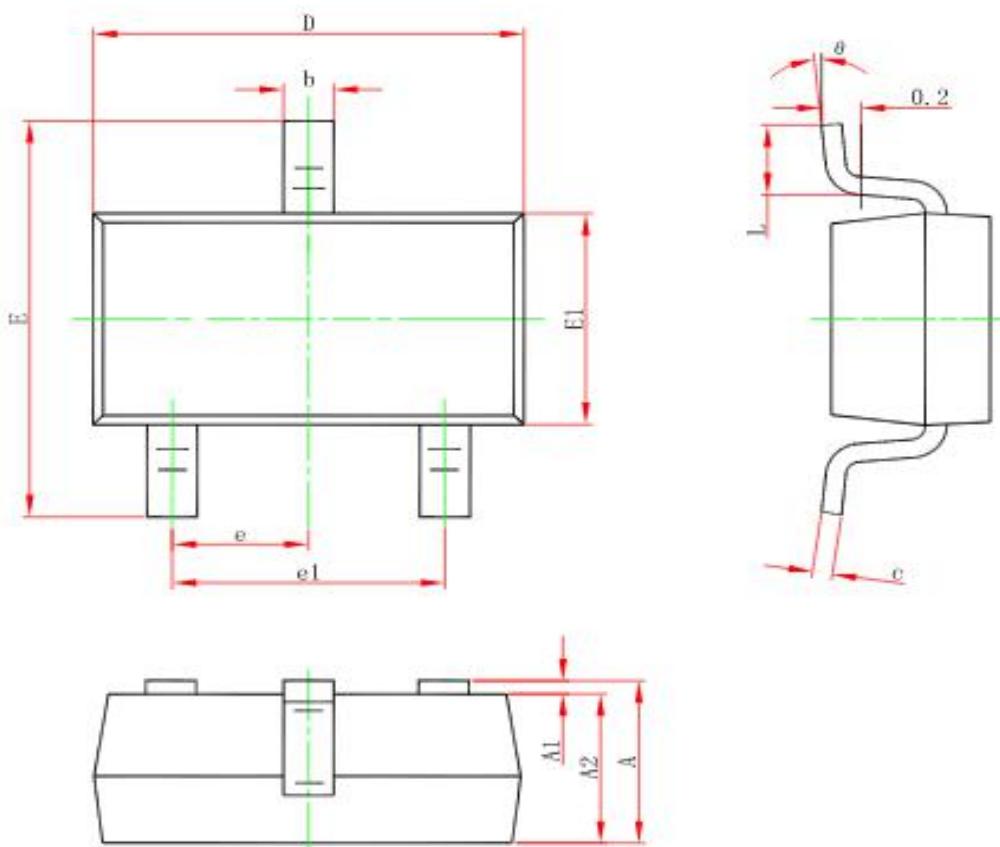
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = -250µA	-20			V
Gate-source threshold voltage	VGS(th)	VDS = VGS, ID = -250µA	-0.4		-1.5	V
Gate-source leakage	IGSS	VDS = 0V, VGS = ±8V			±100	nA
Zero gate voltage drain current	IDSS	VDS = -20V, VGS = 0V			-1	µA
Drain-source on-state resistancea	RDS(on)	VGS = -4.5V, ID = -6A		25	30	mΩ
		VGS = -2.5V, ID = -4A		30	35	mΩ
Forward transconductancea	gfs	VDS = -5V, ID = -5A		20		S
Diode forward voltage	VSD	IS=-1A, VGS=0V		-0.8	-1.5	V
Dynamic						
Input capacitance	Ciss	VDS = -10V, VGS = 0V, f=1MHz		1090		pF
Output capacitance	Coss			155		pF
Reverse transfer capacitanceb	Crss			135		pF
Total gate charge	Qg	VDS = -10V, VGS = -4.5V, ID = -5A		16		nC
Gate-source charge	Qgs			2.5		nC
Gate-drain charge	Qgd			3.2		nC
Gate resistance	Rg	f=1MHz		5		Ω
Switchingb						
Turn-on delay time	td(on)	VDS = -10V RL = 3Ω, ID = -4A, VGEN = -4.5V, Rg = 2Ω		18		ns
Rise time	tr			25		ns
Turn-off delay time	td(off)			42		ns
Fall time	tf			13		ns
Drain-source body diode characteristics						
Continuous Source-Drain Diode Current	IS	Tc=25°C			-2.1	A
Pulsed Diode forward Current	ISM				-20	A

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t < 5 sec.
3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.



SOT-23-3L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°